## **ABM12 Series**

Request Samples (>)



Check Inventory



1.6 x 1.2 x 0.45 mm **RoHS/RoHS II Compliant** MSL Level = N/A



## **Features**

- Suitable for RoHs reflow profile
- Available tight tolerance and stability
- Electron beam sealed ceramic package assures high precision and reliability

# **Applications**

- Bluetooth, Wireless applications
- Computers, Modems, Microprocessors
- Communication, Test equipment
- High density applications
- **PCMCIA**

# **Key Electrical Specifications**

| Parameters   | Minimum                      | Typical | Maximum    | Units                       | Notes                                   |
|--|------------------------------|---------|------------|-----------------------------|---|
| Frequency Range  | 24.000                       |         | 80.000     | MHz                         |   |
| Standard Frequencies   | 26.000, 32.000 and 36.000MHz |         |            |                             | (Contact Abracon for other frequencies) |
| Operation Mode   | Fundamental                  |         |            |                             |   |
| Operating Temperature  | -10                          |         | +50        | °C                          | Option "blank"; See options             |
| Storage Temperature  | -40                          |         | +85        | °C                          |   |
| Frequency Tolerance @+25°C   | -50                          |         | +50        | ppm                         | Option "blank"; See options             |
| Frequency Stability over the Operating Temperature (ref. to +25°C) | -50                          |         | +50        | ppm                         | Option "blank"; See options             |
| Equivalent series resistance (R1)                                  |                              |         | 200<br>100 | Ω                           | 24.000~39.999MHz<br>40.000~80.000 MHz   |
| Shunt capacitance (C0)   |                              |         | 5          | pF                          | 10.000 00.000 11112                     |
| Load capacitance (CL)  | 8                            |         | pF         | Option "blank"; See options |   |
| Drive Level  |                              | 10      | 100        | μW                          |   |
| Aging  | -5                           |         | +5         | ppm                         | @ 25°C±3°C First year                   |
| Insulation Resistance  | 500                          |         |            | MΩ                          | $@ 100 \text{Vdc} \pm 15 \text{V}$      |



# **ABM12 Series Options And Part Identification (Left Blank If Standard)** ABM12-(

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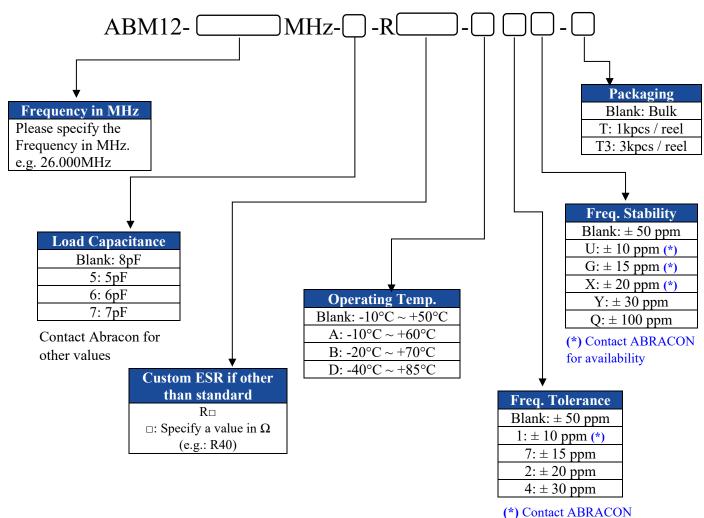
Check Inventory



1.6 x 1.2 x 0.45 mm **RoHS/RoHS II Compliant** 



MSL Level = N/A



for availability

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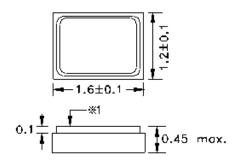


Check Inventory

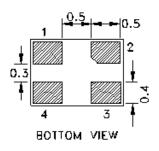


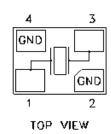
1.6 x 1.2 x 0.45 mm RoHS/RoHS II Compliant MSL Level = N/A

#### **Mechanical Dimensions**

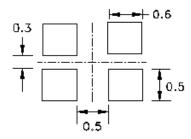


Pin 2 and pin 4 are connected to the metal lid (\*1). (Please connect to GND)





## Recommended land pattern



#### **Dimensions: mm**

**Note 1**: Due to material availability, the outline and finish color of the component lid may vary. This variation in no way affects the electrical performance of the product.

**Note 2**: Due to material availability the Chamfer could be located on pin #1, 2 or 4. Be advised that the Chamfer location has no impact on the electrical performance of the device.



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# **Reflow Profile [JEDEC J-STD-020]**

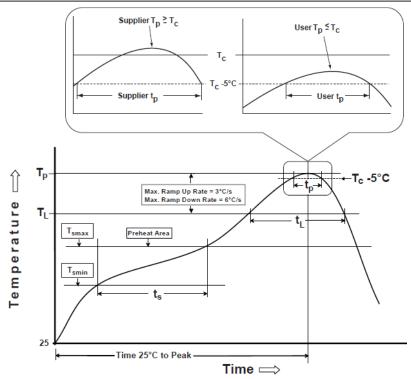


 Table 1

 SnPb Eutectic Process

 Classification Temperatures (Tc)

 Package Thickness
 Volume mm³ 350
 ≥350

 <2.5 mm</td>
 235 °C
 220 °C

 ≥2.5 mm
 220 °C
 220 °C

Table 2

| Pb-Free Process<br>Classification Temperatures (T <sub>c</sub> ) |                    |                                    |                              |  |  |  |
|--|--------------------|------------------------------------|------------------------------|--|--|--|
| Package<br>Thickness   | Volume mm³<br><350 | Volume mm <sup>3</sup><br>350-2000 | Volume mm <sup>3</sup> >2000 |  |  |  |
| <1.6 mm  | 260 °C             | 260 °C                             | 260 °C                       |  |  |  |
| 1.6 mm - 2.5 mm  | 260 °C             | 250 °C                             | 245 °C                       |  |  |  |
| >2.5 mm  | 250 °C             | 245 °C                             | 245 °C                       |  |  |  |

| Profile Feature  | Sn-Pb Eutectic<br>Assembly | Pb-Free<br>Assembly |
|--|----------------------------|---------------------|
| Preheat / soak   |                            |                     |
| Temperature minimum (T <sub>smin</sub> )   | 100°C                      | 150°C               |
| Temperature maximum (T <sub>smax</sub> )   | 150°C                      | 200°C               |
| Time $(T_{smin} \text{ to } T_{smax})$ $(t_s)$                                   | 60 - 120 sec.              | 60 - 120 sec.       |
| Average ramp-up rate (T <sub>smax</sub> to T <sub>P</sub> )                      | 3°C/sec. max               | 3°C/sec. max        |
| Liquidous temperature (T <sub>L</sub> )  | 183°C                      | 217°C               |
| Time at liquidous (t <sub>L</sub> )  | 60 - 150 sec.              | 60 - 150 sec.       |
| Peak package body temperature (T <sub>P</sub> )*                                 | see Table 1                | see Table 2         |
| Time $(t_p)^{**}$ within 5°C of the specified classification temperature $(T_c)$ | 20 sec.                    | 30 sec.             |
| Ramp-down rate (T <sub>p</sub> to T <sub>smax</sub> )                            | 6°C/sec. max               | 6°C/sec. max        |
| Time 25°C to peak temperature  | 6 min. max                 | 8 min. max          |
| Reflow cycles  | 2 max                      | 2 max               |

<sup>\*</sup>Tolerance for peak profile temperature (Tp) is defined as a supplier minimum and a user maximum.



<sup>\*\*</sup>Tolerance for time at peak profile temperature (tp) is defined as supplier minimum and a user maximum.

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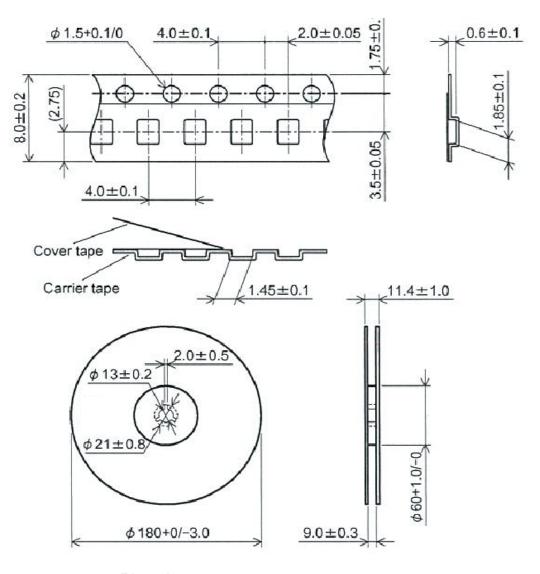


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## **Packaging**

**Option "-T":** Tape and reel (1,000pcs/reel)

Option "-T3": Tape and reel (3,000pcs/reel)



Dimensions: mm

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